

C0805C473M3TACTU

Aliases (C0805C473M3TAC7800) SMD Comm X8G HT150C, Ceramic, 0.047 uF, 20%, 25 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.7 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	14 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
т	1.25mm +/-0.15mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

Packaging SpecificationsPackagingT&R, 180mm, Plastic TapePackaging Quantity2500

Specifications		
Capacitance	0.047 uF	
Measurement Condition	1 kHz 1.0Vrms	
Tolerance	20%	
Voltage DC	25 VDC	
Dielectric Withstanding Voltage	62.5 VDC	
Temperature Range	-55/+150°C	
Temp. Coefficient	X8G	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms	
Dissipation Factor	0.1% 1 kHz 1.0Vrms	
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	21.2766 GOhms	

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